

1/25/05

PTO-1595

RE

02-07-2005

SHEET U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office



To the Honorable Commissioner of Pa

102935762

Attached original documents or copy thereof.

1 Name of conveying party(ies):

BURN-JENG LIN
CHING-YU CHANG

2 Name and address of receiving party(ies):

Taiwan Semiconductor Manufacturing Co. Ltd.
No. 8. Li-Hsin Rd. 6
Science-Based Industrial Park
Hsin-Chu, Taiwan, R.O.C.

112975 U.S. PTO
11/043598

012505

3 Nature of conveyance:

- Assignment Merger
 - Security Agreement Change of Name
 - Other:
- Execution Date: 11/17/2004

Additional name(s) & address(es) attached Yes No

4 Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 11/17/2004

A. Patent Application No(s).

B. Patent No(s)

Additional numbers attached? Yes No

5 Name and address of party to whom correspondence concerning document should be mailed:

RANDY W. TUNG
Tung & Associates
838 W. Long Lake Road
Suite 120
Bloomfield Hills, Michigan 48302

6 Total number of applications and patents involved:

1

7 Total fee (37 CFR 3.41)

\$1,990.00

- Enclosed
- Authorized to charge credit card (w/filing fee)

8 Deposit Account Number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Randy W. Tung
Name of Person Signing
Registration No. 31,311

Signature

Date

1/24/05

Total number of pages including cover sheet, attachments, and document : 3

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

67,200-1345

02/02/2005 HNGUYEN1 00000008 11043598

05 FC:8021

40.00 DP

PATENT
REEL: 016223 FRAME: 0255

ASSIGNMENT

WHEREAS, we, BURN-JENG LIN and CHING-YU CHANG, have invented certain improvements in


RESIST COLLAPSE PREVENTION USING IMMERSED HARDENING

for which I am about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 8, Li-Hsin Rd 6, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, BURN-JENG LING and CHING-YU CHANG, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 17th day of November, 2004, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.


BURN-JENG LIN


CHING-YU CHANG

TUNG & ASSOCIATES
838 W. Long Lake Road
Suite 120
Bloomfield Hills, Michigan 48302